Our commitment, Your advantage

**Customer Support** 

Home > Products > By Type > Removable Memory Products - > Product Feature Selector - > Product Details

#### 5146228 - 3 Product Details



5146228



## PC Card (PCMCIA) Connectors & Accessories

Always EU RoHS/ELV Compliant (Statement of Compliance)

#### **Product Highlights:**

- Receptacle
- CardBus Application
- PCB Offset = 0.00 mm
- Lead Type = Surface Mount Staggered leads
- Number of Positions = 68

View all Features | Find Similar <u>Products</u>

# Live Product Chat US

#### **Quick Links**

Check Pricing & Availability Search for Tooling Product Feature Selector Contact Us About This Product

#### **Documentation & Additional Information**

#### **Product Drawings:**

? RECEPTACLE ASSEMBLY, SURFACE MOUNT, 68 POSITION, ZER. (PDF, English)

#### Catalog Pages/Data Sheets:

None Available

#### **Product Specifications:**

? None Available

#### **Application Specifications:**

#### Instruction Sheets:

None Available

## CAD Files: (CAD Format & Compression Information

- 2 2D Drawing (DXF, Version O)
- 2 3D Model (IGES, Version O)
- ? 3D Model (STEP, Version O)

**List all Documents** 

## Additional Information:

Product Line Information

#### Related Products:

? Tooling

Product Features (Please use the Product Drawing for all design activity)

## **Product Type Features:**

- ? Product Type = Receptacle
- ? Number of Positions = 68
- ? Shielded = No
- ? Mating Polarization = Without
- ? Holddowns = Without
- ? Color = Black
- Comment = I/O header should have the same PCB offset as receptacle.

## **Mechanical Attachment:**

2 Lead Length (mm [in]) = 1.50 [0.059]

## Termination Related Features:

Solder Tail Contact Plating = Tin

## **Body Related Features:**

- ? PCB Offset (mm [in]) = 0.00 [0.000]
- ? <u>Lead Type</u> = Surface Mount Staggered leads
- ? Number of Rows = Dual
- ? Centerline (mm [in]) = 1.27 [0.050]

## **Contact Related Features:**

- Contact Mating Area Plating Material (30) over Nickel (30)
- Region = Americas
- ? Contact Material = Beryllium Copper
- ? Contact Underplating = Nickel (50)

## Housing Related Features:

Housing Material = Liquid Crystal Polymer (LCP)

#### Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV
- <u>Lead Free Solder Processes</u> = Reflow solder capable to 245°C, Reflow solder capable to
- RoHS/ELV Compliance History = Always was RoHS compliant

## Operation/Application:

? Application = CardBus

#### **Packaging Related Features:**

Packaging Method = Tape Mounted on Reel

### Other:

Prand = AMP

Provide Website Feedback | Contact Customer Support